



Product Change Notification

Change Notification #: 118915-00
Change Title: Select Intel® Ethernet Converged Network Adapter X550-T1, and Intel® Ethernet Converged Network Adapter X550-T2, PCN 118915-00, Transport Media, Clamshell Packaging Update
Date of Publication: February 28, 2022

Key Characteristics of the Change:

Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	April 18, 2022
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Description of Change to the Customer:

The Intel® SKUs listed in the products affected table below will have the following change(s):

- The clamshell material was updated from APET AS-E616T00 to a more robust APET material, TLL-APET-100D-T80, that can help withstand higher temperatures and humidity. This will help to optimize clamshell sustainability and transportation of products.
- In addition, the Intel logo will be updated and the Intel part number on the clamshell will update from D73279-003 to D73279-004.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Customers can expect to receive mixed inventory.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® Ethernet Converged Network Adapter X550-T1, Single Pack	X550T1	940116
Intel® Ethernet Converged Network Adapter X550-T1, 5 Pack	X550T1BLK	940125
Intel® Ethernet Converged Network Adapter X550-T2, Single Pack	X550T2	940128
Intel® Ethernet Converged Network Adapter X550-T2, 5 Pack	X550T2BLK	940136
Intel® Ethernet Converged Network Adapter X550-T2, 5 Pack	X550T2G1P5	940263

PCN Revision History:

Date of Revision:

February 28, 2022

Revision Number:

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Reason:

Originally Published PCN



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118915-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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